507691540 01/12/2023

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7738683

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
DAN LIU	01/03/2023

RECEIVING PARTY DATA

Name:	HYTTO PTE. LTD.
Street Address:	20 EMERALD HILL ROAD
City:	SINGAPORE
State/Country:	SINGAPORE
Postal Code:	229302
Name:	DONGGUAN AISI HEALTH CARE PRODUCTS CO., LTD.
Street Address:	FLOOR 4, BUILDING J, FULIN INDUSTRIAL PARK
Internal Address:	TAIGONGLING VILLAGE, DALINGSHAN TOWN
City:	DONGGUAN
State/Country:	CHINA
Postal Code:	523074

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18153423

CORRESPONDENCE DATA

Fax Number: (408)273-4555

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (408) 777-6712

Email: marcia.shea@evlg.com

Correspondent Name: EVERGREEN VALLEY LAW GROUP

Address Line 1: 2570 NORTH FIRST STREET

Address Line 2: SUITE 200

Address Line 4: SAN JOSE, CALIFORNIA 95131

ATTORNEY DOCKET NUMBER:	HYTT-P013	
NAME OF SUBMITTER: KANIKA RADHAKRISHNAN		
SIGNATURE:	/Kanika Radhakrishnan/	

PATENT 507691540 REEL: 062355 FRAME: 0786

DATE SIGNED:	01/12/2023	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2		
source=HYTT-P013_Assignment-Declaration#page1.tif		
source=HYTT-P013_Assignment-Declaration#page2.tif		

PATENT REEL: 062355 FRAME: 0787

DOCKET NUMBER: HYTT-P013

DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: STIMULATION DEVICE

As a below named and undersigned inventor, I hereby declare that:
This declaration is directed to the attached application, or (if following box is checked):
[X] United States application 18/153,423 filed on January 12, 2023
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
I have reviewed and understand the contents of the application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the Docket Number provided above in the header of this document;

Whereas **HYTTO PTE. LTD.** (herein referred to as the "ASSIGNEE") having a place of business at 20 Emerald Hill Road, Singapore 229302 and **DONGGUAN AISI HEALTH CARE PRODUCTS CO., LTD.** (herein referred to as the "ASSIGNEE") having a place of business at Floor 4, Building J, Fulin Industrial Park, Taigongling Village, Dalingshan Town, Dongguan, Guangdong desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefore in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting

Page 1 of 2

DOCKET NUMBER: HYTT-P013

from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

RECORDED: 01/12/2023

Signature:	/Dan LIU/	Date:	Jan 03, 2023

Page 2 of 2